Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	5	(dielectric or insulat\$3) and (thermal near treatment) and (mechanical near stability).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 12:42
L2	36219	(mechanical near3 stability)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 12:42
L3	274	(dielectric near10 low\$3) with (mechanical near3 stability)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 12:47
L4	11	3 and (second near3 treatment)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 12:43
L5	34058	(second near3 treatment)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 12:47
L6	45	(second near3 treatment) near15 ((low) near3 (dielectric or insulat\$3))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 12:48
L7	9	(second near treatment) near15 ((low) near3 (dielectric or insulat\$3))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 12:49
L8	1031	(second near3 treatment) and ((low) near3 (dielectric or insulat\$3))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 12:50
L9	255	8 and (first near treatment)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 12:50

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L10	99	9 and (low near dielectric)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 12:50
L11	43	10 and (second near treatment)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 13:27
L12	41	11 and (chemical or stabilit\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 12:51
L13	1	11 and (mechanical near3 stabilit\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 12:52
L14	30	11 and (mechanical or stabilit\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 12:52
L15	28	11 and plasma	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 13:43
L16	13	14 and hydrogen	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 13:29
L17	4	14 and (hydrogen-plasma or hydrogen near plasma)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 13:30
L18	3	14 and (uv near ultraviolet)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 13:32
L19	9	14 and (electron or beam)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 13:32

L20	84268	(hydrogen near3 plasma) or ((uv	US-PGPUB;	OR	ON	2005/08/04 13:45
LZU	01200	or ultraviolet) near (radiation))	USPAT; EPO; JPO; DERWENT; IBM_TDB	OK .	OIV	2003/00/04 13.43
L21	32859	20 and (treatment)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 13:45
L22	698	21 and (first near treatment)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 14:00
L23	13	21 and (first near treatment) with (hydrogen near3 plasma)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 13:51
L24	27	21 and (first near treatment) with (uv or ultraviolet)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 13:52
L25		21 and (first near treatment) with (microwave near hydrogen near plasma)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 14:00
L26		21 and (first near treatment) same (microwave near hydrogen near plasma)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 14:00
L27	15	(microwave near hydrogen near plasma)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 14:22
L28	9	27 and treatment	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 14:01
L29	0	27 and (first near3 treatment)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 14:01

L30	203	(microwave near3 hydrogen near3 plasma)	US-PGPUB; USPAT; EPO; JPO; DERWENT;	OR	ON	2005/08/04 14:22
L31	92	30 and (treatment)	IBM_TDB US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 14:22
L32	55	31 and (treatment) with (hydrogen)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 14:23
L33	25	31 and (treatment) with (microwave)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 14:23
L34	3	31 and (treatment) with (microwave near hydrogen)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 14:24
L35	74554	(uv or ultraviolet) near (radiation)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 14:25
L36	28094	35 and (treatment\$1)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 14:25
L37	6658	35 and (treatment\$1) near25 (uv or ultraviolet)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 14:25
L38	106	35 and (second near3 treatment\$1) near25 (uv or ultraviolet)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 14:26
L39	27	38 and (first near3 treatment) near25 (uv or ultraviolet)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 14:28

L40	0	39 and dilelectric	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 14:28
L41	4	39 and dielectric	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 14:31
L42	175976	(electron near beam)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 14:32
L43	4828	(treatment) near25 (electron near beam)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 14:32
L44		(second near3 treatment) near25 (electron near beam)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 14:32
L45	. 5	44 and dielectric	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/04 14:35